

RESPONSE UNDER 37 CFR 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP 2811

PATENT APPLICATION
Docket No.: 9898-208
Client Ref. No.: SS-15400-US-RCE-RCE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Ki-Won CHOI

Serial No.: 10/055,266 Examiner: Nadav, Ori
Filed: January 22, 2002 Group Art Unit: 2811
Confirmation No.: 6747
For: SEMICONDUCTOR PACKAGE HAVING CHANGED SUBSTRATE
DESIGN USING SPECIAL WIRE BONDING
Date: January 10, 2007

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER FINAL REJECTION UNDER 37 CFR 1.116

Responsive to the Final Office Action, Paper No. 20061001, dated October 11, 2006,
please amend the application as follows.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Drawings begin on page 3 of this paper and include both an
attached replacement sheet and an annotated sheet showing changes.

Amendments to the Claims are reflected in the listing of claims which begins on page 4
of this paper.

Remarks/Arguments begin on page 7 of this paper.

An **Appendix** including amended drawing figures is attached following page 10 of this paper.

do not etc
on 1/19/07